

tech topic

... the next generation in seed treatments

- Superior control of smuts and bunt
- New systemic fungicide with excellent seed safety
- Unique micro-emulsion formulation providing;
 - ease of application
 - exceptional seed flow
 - reduced dust off
- Impeccable seedling emergence and early plant vigour
- Insecticide for stored grain insect control







Rancona ← is proven to be an outstanding seed treatment for wheat, barley and oats. It combines excellent control of smuts, bunt and stored grain insects with impeccable safety to seedling emergence and viability.

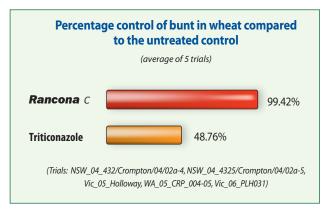


For superior control of smuts and bunt

Nil tolerance for smuts and bunt means control of these diseases is vital to prevent rejection at delivery.

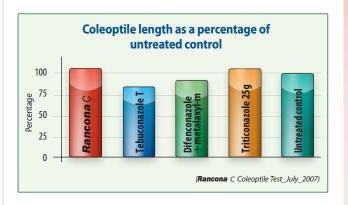
Ipconazole, the fungicide in **Rancona** *C*, has both preventative and curative activity against fungi.

Rancona *C* provides improved control of covered smut (common bunt), seed and soil-borne flag smut and loose smut in wheat, barley and oats.



Seed safety

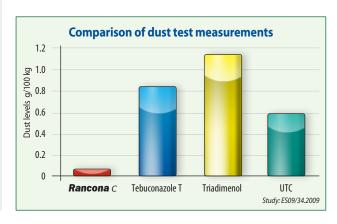
Rancona C shows superior seed safety when compared with other triazole seed treatments with no negative effects on the seedling coleoptile length. This can improve emergence and early plant vigour.



Unique micro-emulsion formulation

The **Rancona** *C* micro-emulsion formulation provides greater flexibility for users offering easier application, exceptional seed flow of seed through machinery, easier cleandown of equipment and reduced dust off.

The specially formulated micro-emulsion has superior adherence to seed, compared to other seed treatment formulations resulting in low dust potential and therefore does not rub off during subsequent handling.



Insect Control



Always refer to the registered label for complete details



Rancona is a registered trademark of Chemtura Corporation

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